imall

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PHOTOCOUPLER PS9114

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP PHOTOCOUPLER –NEPOC Series–

DESCRIPTION

The PS9114 is an optically coupled high-speed, isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

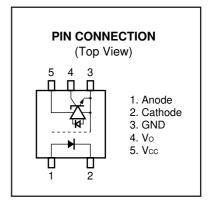
The PS9114 is specified high CMR, high CTR and pulse width distortion with operating temperature.

FEATURES

- High common mode transient immunity (CMH, CML = $\pm 20 \text{ kV}/\mu \text{s TYP.}$)
- Small package (5-pin SOP)
 - Pulse width distortion ($|t_{PHL} t_{PLH}| = 3 \text{ ns TYP.}$)
 - High-speed (10 Mbps)
 - High isolation voltage (BV = 2 500 Vr.m.s.)
 - · Open collector output
 - Ordering number of taping product: PS9114-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No. 40008902 (Option)

APPLICATIONS

- Measurement equipment
- PDP
- FA Network

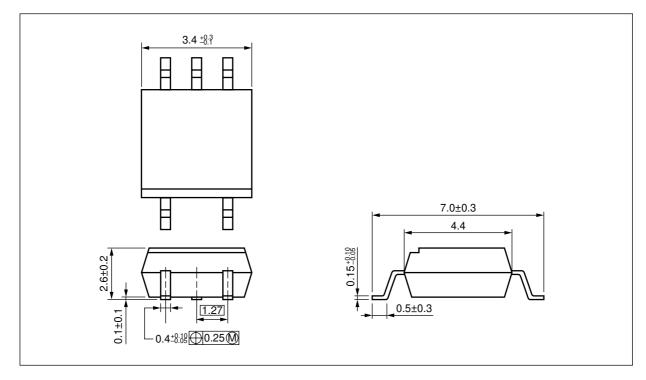


TRUTH TABLE

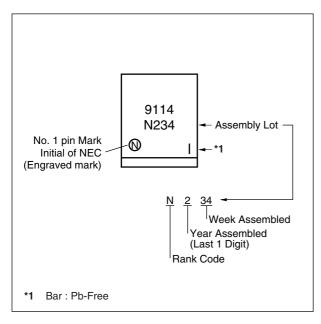
LED	Output
ON	L
OFF	Н

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PACKAGE DIMENSIONS (UNIT: mm)



* MARKING



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS9114	PS9114-A	Pb-Free ^{*2}	Magazine case 100 pcs	Standard products	PS9114
PS9114-F3	PS9114-F3-A		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9114-F4	PS9114-F4-A				
PS9114-V	PS9114-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS9114-V-F3	PS9114-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9114-V-F4	PS9114-V-F4-A			Approved (Option)	

- *1 For the application of the Safety Standard, following part number should be used.
- *2 With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Parameter		Symbol Ratings		Unit
Diode	Forward Current ^{*1}	lf	30	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	V
	Output Current	lo	25	mA
	Power Dissipation *2	Pc	40	mW
Isolation Voltage *3 Operating Ambient Temperature Storage Temperature		BV	2 500	Vr.m.s.
		TA	-40 to +85	°C
		Tstg	-55 to +125	°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

- *1 Reduced to 0.3 mA/°C at $T_A = 25^{\circ}C$ or more.
- *2 Applies to output pin Vo. Reduced to 1.5 mW/°C at TA = 65°C or more.
- *3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

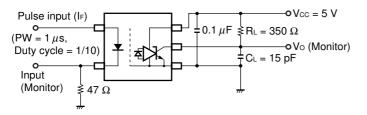
RECOMMENDED OPERATING CONDITIONS

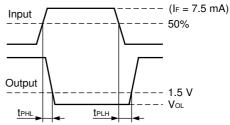
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	VFL	0		0.8	V
High Level Input Current	IFH	6.3	10	12.5	mA
Supply Voltage	Vcc	4.5	5.0	5.5	V
TTL (R∟ = 1 kΩ, loads)	N			5	
Pull-up resistor	R∟	330		4 k	Ω

ELECTRICAL CHARACTERISTICS (Unless otherwise specified, $T_A = -40$ to $+85^{\circ}C$)

	Parameter		Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	I⊧ = 10 mA, T₄ = 25°C	1.4	1.65	1.9	V
	Reverse Current	IR	Vr = 3 V, Ta = 25°C			10	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5.5 V, VF = 0.8 V		0.02	250	μA
	Low Level Output Voltage ^{*2}	Vol	Vcc = 5.5 V, I⊧ = 5 mA, Io∟ = 13 mA		0.15	0.6	V
	High Level Supply Current	Іссн	Vcc = 5.5 V, I⊧ = 0 mA, Vo = open		3	8	mA
	Low Level Supply Current	Iccl	Vcc = 5.5 V, I⊧ = 10 mA, Vo = open		7.0	11	mA
Coupled	Threshold Input Current	IFHL	$V_{CC} = 5 \text{ V}, \text{ V}_{O} = 0.8 \text{ V}, \text{ R}_{L} = 350 \Omega$		2	5	mA
	$(H\toL)$						
	Isolation Resistance	R ⊦o	V⊦o = 1 kVbc, RH = 40 to 60%, T _A = 25°C	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time	tрнг	T _A = 25°C		54	75	ns
	$(H \rightarrow L)^{*3}$		Vcc = 5 V, RL = 350 Ω, I⊧ = 7.5 mA			100	
	Propagation Delay Time	tрін	T _A = 25°C		51	75	ns
	$\left(L \rightarrow H\right)^{*3}$		Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA			100	
	Rise Time	tr	Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA		20		
	Fall Time	tr	Vcc = 5 V, R∟ = 350 Ω, I⊧ = 7.5 mA		10		
	Pulse Width Distortion (PWD) *3	tphl-tplh	$V_{CC} = 5 \text{ V}, \text{ R}_{\text{L}} = 350 \ \Omega, \text{ I}_{\text{F}} = 7.5 \text{ mA}$		3	50	ns
	Propagation Delay Skew	tрsк	$V_{CC} = 5 \text{ V}, \text{ R}_{\text{L}} = 350 \ \Omega, \text{ I}_{\text{F}} = 7.5 \text{ mA}$			60	
	Common Mode Transient Immunity at High Level Output ^{*4}	СМн		10	20		kV/μs
	Common Mode Transient Immunity at Low Level Output ^{*4}	CM∟	$ \begin{array}{l} R_{\text{L}} = 350 \; \Omega, \; T_{\text{A}} = 25^{\circ} C, \; \text{IF} = 7.5 \; \text{mA}, \\ V_{\text{O}\;(\text{MAX.})} = 0.8 \; \text{V}, \; \text{V}_{\text{CM}} = 1 \; \text{kV} \end{array} $	10	20		kV/μs

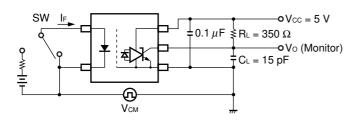
- *1 Typical values at $T_A = 25^{\circ}C$
- *2 Because VoL of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *3 Test circuit for propagation delay time

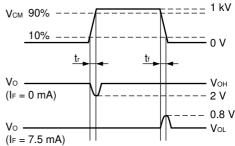




Remark CL includes probe and stray wiring capacitance.

*4 Test circuit for common mode transient immunity



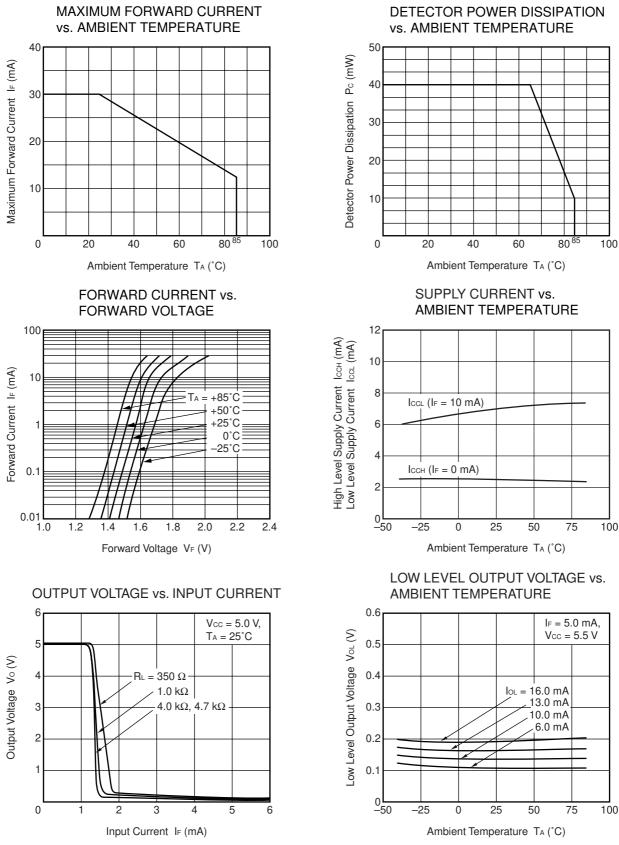


Remark CL includes probe and stray wiring capacitance.

USAGE CAUTIONS

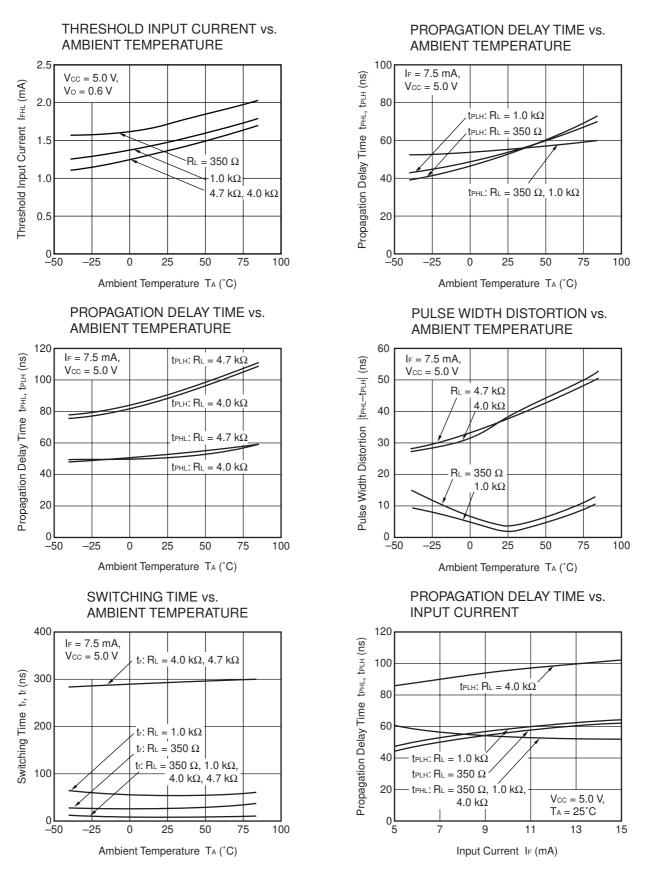
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.





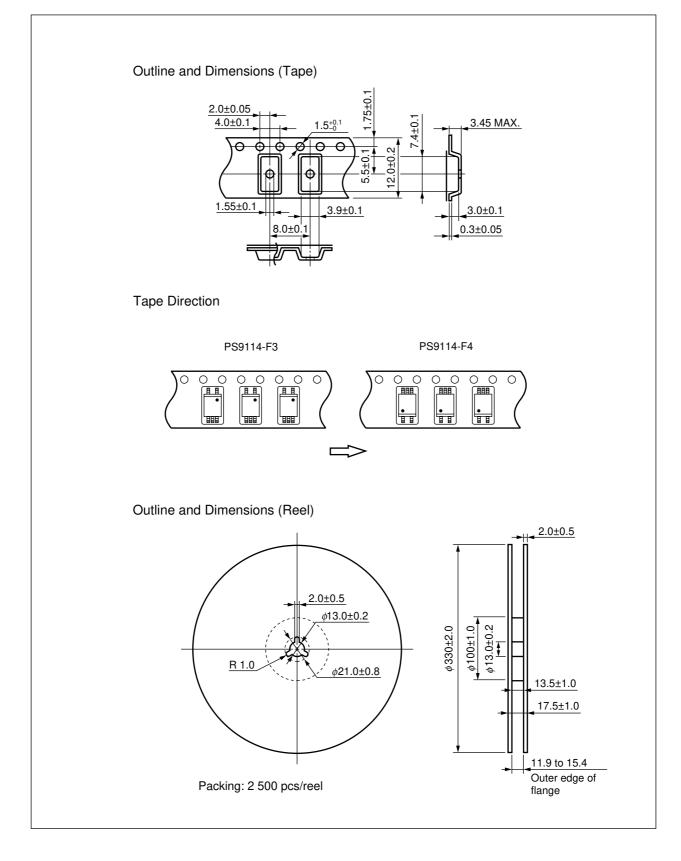
Remark The graphs indicate nominal characteristics.

Data Sheet PN10266EJ02V0DS



Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



Data Sheet PN10266EJ02V0DS

NOTES ON HANDLING

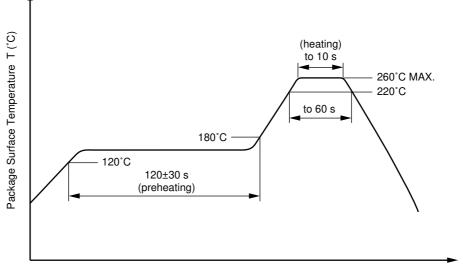
1. Recommended soldering conditions

(1) Infrared reflow soldering

- · Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

★ (3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
 Time (each pins) 	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over $100^{\circ}C$

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ USAGE CAUTIONS

1. Protect against static electricity when handling.

2. Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

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	 Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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